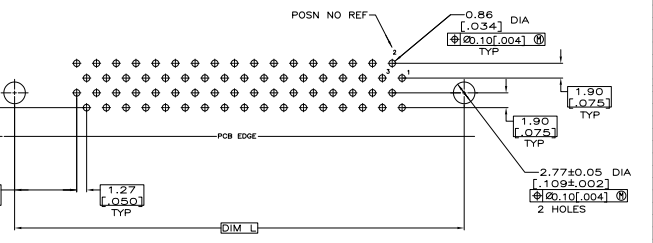
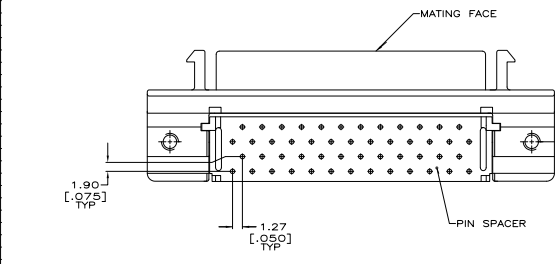


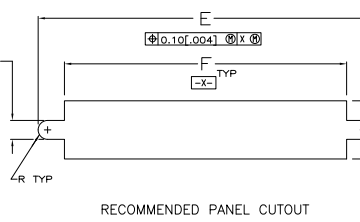
P.C. BOARD MOUNTING DIMENSIONS
CONECTOR SIDE
P.C. BOARD THICKNESS 1.57±0.20 [0.062±0.008]
PC BOARD PATTERN S



P.C. BOARD MOUNTING DIMENSIONS
CONECTOR SIDE
P.C. BOARD THICKNESS 1.57±0.20 [0.062±0.008]
PC BOARD PATTERN T

MATERIAL
CONTACTS: PHOSPHOR BRONZE
HOUSING & PIN SPACER: UL 94V-0 RATED, THERMOPLASTIC, BLACK
BRACKET: ZINC
SHELL: CARBON STEEL

FINISH
CONTACTS: EITHER 0.76µm [0.000030] MIN GOLD PLATE FOR A LENGTH OF 0.64 [0.025] MAX, 0.13 [0.005] MIN FROM MATING END OR GOLD FLASH OVER PALLADIUM NICKEL PLATE, 0.76µm [0.000030] MIN TOTAL FOR A LENGTH OF 0.64 [0.025] MAX, 0.13 [0.005] MIN FROM MATING END. 3.81µm [0.000150] MIN TIN-LEAD ON OPPOSITE END FOR A LENGTH OF 2.72 [0.107] MIN, BOTH OVER 1.27µm [0.000050] MIN NICKEL.
SHELL: 5.08µm [0.000200] MIN NICKEL OVER 1.27µm [0.000050] MIN COPPER.
BRACKET: 2.54µm [0.000100] MIN NICKEL OVER 5.08µm [0.000200] COPPER.



PC BOARD PATTERN	L	G	F	E	D	B	A	NO OF POSN	PART NUMBER	
OBsolete	T	78.23	0.64	74.55	80.67	84.20	66.45	78.23	100	787394-9
	T	3.080	[0.025]	2.935	3.178	3.315	2.618	3.080		
	T	65.53	0.64	61.85	67.97	71.50	53.75	65.53	80	787394-8
	T	2.580	[0.025]	2.435	2.678	2.815	2.116	2.580		
	T	57.91	0.64	54.23	60.35	63.88	46.13	57.91	68	787394-7
	T	2.280	[0.025]	2.135	2.378	2.515	1.816	2.280		
	S	46.48	1.27	42.80	48.92	52.45	34.70	46.48	50	787394-5
	S	1.830	[0.050]	1.685	1.928	2.065	1.366	1.830		
	T	32.51	0.64	28.83	34.95	38.48	20.73	32.51	28	787394-3
	T	1.280	[0.025]	1.135	1.378	1.515	1.016	1.280		
	S	31.24	1.27	27.56	33.68	37.21	19.46	31.24	26	787394-2
	S	1.230	[0.050]	1.085	1.328	1.465	1.016	1.230		

THIS DRAWING IS A CONTROLLED DOCUMENT. RELEASED TO THE PUBLIC BY THE ELECTRONICS CORPORATION. DATE: 108-1228. 114-40029. 100779 (G)=787394. CUSTOMER DRAWING. SIZE: 4.1 x 1.1 x 1.1. RECEPTACLE ASSEMBLY, SHIELDED. RIGHT ANGLE, 000 SERIES AMP/MLTE.